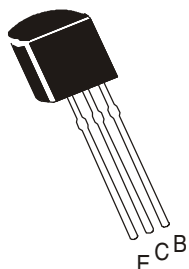


NPN SILICON PLANAR EPITAXIAL TRANSISTOR

CD965



TO-92
Plastic Package

For Low Frequency Power Amplification

ABSOLUTE MAXIMUM RATINGS

DESCRIPTION	SYMBOL	VALUE	UNITS
Collector Emitter Voltage	V_{CEO}	20	V
Collector Base Voltage	V_{CBO}	40	V
Emitter Base Voltage	V_{EBO}	7	V
Collector Current	I_C	5	A
Collector Current Peak	I_{CP}	8	A
Power Dissipation @ $T_a=25^\circ\text{C}$	P_C	0.75	W
Junction Temperature	T_j	150	$^\circ\text{C}$
Storage Temperature Range	T_{stg}	- 55 to +150	$^\circ\text{C}$

ABSOLUTE MAXIMUM RATINGS($T_a=25^\circ\text{C}$ unless specified otherwise)

DESCRIPTION	SYMBOL	TEST CONDITION	MIN	TYP	MAX	UNITS
Collector Emitter Voltage	V_{CEO}	$I_C=1\text{mA}, I_B=0$	20			V
Collector Base Voltage	V_{CBO}	$I_C=100\mu\text{A}, I_E=0$	40			V
Emitter Base Voltage	V_{EBO}	$I_E=10\mu\text{A}, I_C=0$	7			V
Collector Cut Off Current	I_{CBO}	$V_{CB}=10\text{V}, I_E=0$			100	nA
Emitter Cut Off Current	I_{EBO}	$V_{EB}=7\text{V}, I_C=0$			100	nA
DC Current Gain	h_{FE}	* $I_C=500\text{mA}, V_{CE}=2\text{V}$ $I_C=2\text{A}, V_{CE}=2\text{V}$	180 150		600	
Collector Emitter Saturation Voltage	$V_{CE(sat)}$	$I_C=3\text{A}, I_B=100\text{mA}$			1.35	V
Base Emitter Saturation Voltage	$V_{BE(sat)}$	$I_C=1\text{A}, I_B=25\text{mA}$			1.20	V

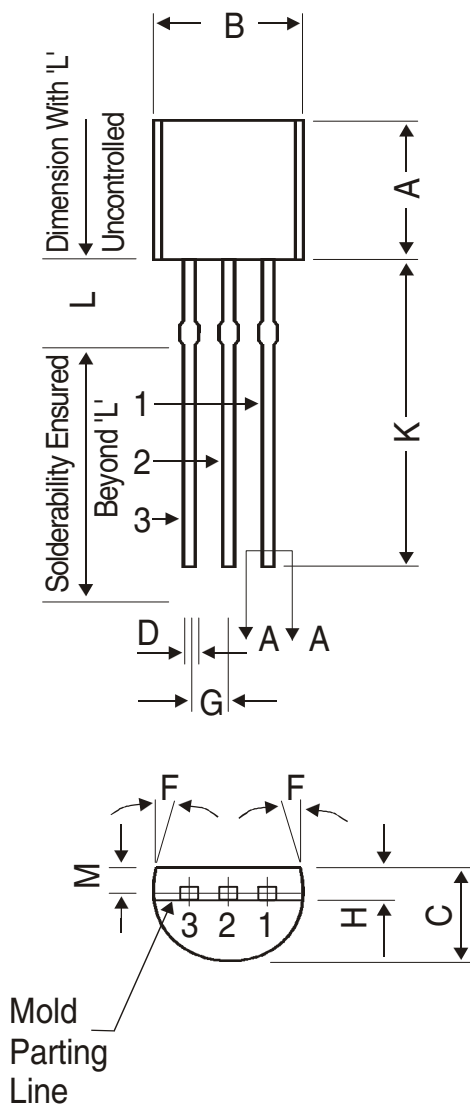
DYNAMIC CHARACTERISTICS

DESCRIPTION	SYMBOL	TEST CONDITION	MIN	TYP	MAX	UNITS
Output Capacitance	C_{ob}	$I_E=0, V_{CB}=20\text{V}, f=1\text{MHz}$			50	pF
Transition Frequency	f_T	$I_C=50\text{mA}, V_{CE}=6\text{V}$		150		MHz

* h_{FE} Classification	P : 180 - 270	Q : 230 - 380	R : 340 - 600
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TO-92 Plastic Package

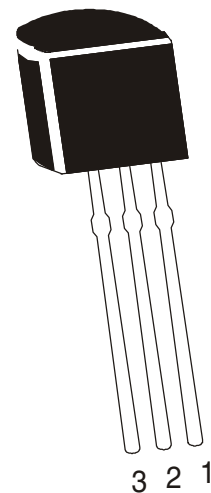


DIM	MIN.	MAX.
A	4.32	5.33
B	4.45	5.20
C	3.18	4.19
D	0.41	0.55
E	0.35	0.50
F	5 DEG	
G	1.14	1.40
H	1.20	1.40
K	12.70	—
L	1.982	2.082
M	1.03	1.20

All dimensions are in mm

PIN CONFIGURATION

1. BASE
2. COLLECTOR
3. EMITTER



The TO-92 Package, Tape and Ammo Pack Drawings are correct as on the date of issue/revision of this Data Sheet.

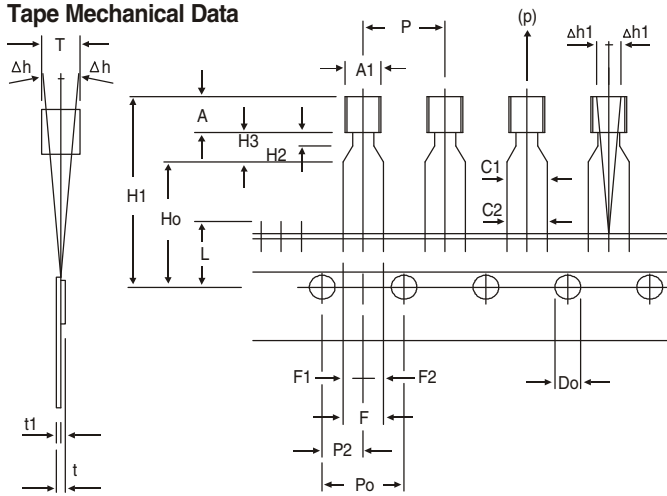
The currently valid dimensions and information, may please be confirmed from the TO-92 Drawing in the Packages and Packing Section of the Product Catalogue.

Packing Details

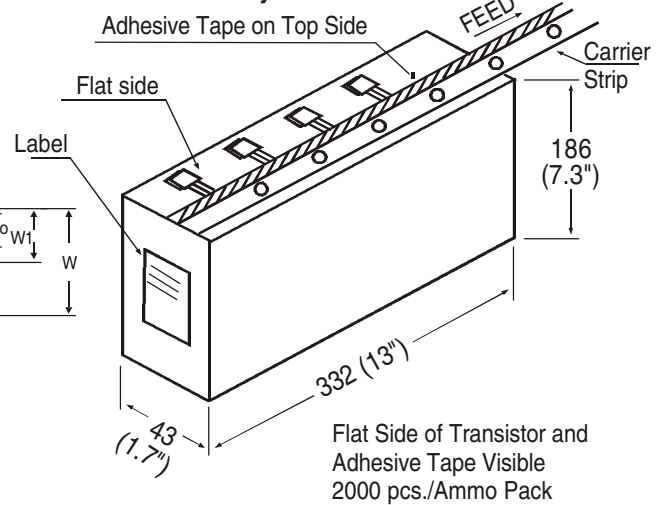
PACKAGE	STANDARD PACK		INNER CARTON BOX		OUTER CARTON BOX		
	Details	Net Weight/Qty	Size	Qty	Size	Qty	Gr Wt
TO-92 Bulk	1K/polybag	200 gm/1K pcs	3" x 7.5" x 7.5"	5K	17" x 15" x 13.5"	80K	23 kgs
TO-92 T&A	2K/ammo box	645 gm/2K pcs	12.5" x 8" x 1.8"	2K	17" x 15" x 13.5"	32K	12.5 kgs

TO-92 Tape and Ammo Pack

Tape Mechanical Data



Ammo Pack Style



All dimensions are in mm

ITEM	SYMBOL	SPECIFICATION			
		MIN.	NOM.	MAX.	TOL.
BODY WIDTH	A1	4.0		4.8	
BODY HEIGHT	A	4.8		5.2	
BODY THICKNESS	T	3.9		4.2	
PITCH OF COMPONENT	P		12.7		± 1.0
*1 FEED HOLE PITCH	Po		12.7		± 0.3
*2 FEED HOLE CENTRE TO COMPONENT CENTRE	P2		6.35		± 0.4
DISTANCE BETWEEN OUTER LEADS	F		5.08		+ 0.6 - 0.2
*3 COMPONENT ALIGNMENT SIDE VIEW	Δh		0	1.0	
*4 COMPONENT ALIGNMENT FRONT VIEW	$\Delta h1$		0	1.3	
TAPE WIDTH	W		18		± 0.5
HOLD-DOWN TAPE WIDTH	Wo		6		± 0.2
HOLE POSITION	W1		9		+ 0.7 - 0.5
HOLD-DOWN TAPE POSITION	W2		0.5		± 0.2
LEAD WIRE CLINCH HEIGHT	Ho		16		± 0.5
COMPONENT HEIGHT	H1			23.25	
LENGTH OF SNIPPED LEADS	L			11.0	
FEED HOLE DIAMETER	Do		4		± 0.2
*5 TOTAL TAPE THICKNESS	t			1.2	
LEAD - TO - LEAD DISTANCE	F1, F2		2.54		+ 0.4 - 0.1
STAND OFF	H2	0.45		1.45	
CLINCH HEIGHT	H3			3.0	
LEAD PARALLELISM	C1 - C2			0.22	
PULL - OUT FORCE	(p)	6N			

NOTES

1. Maximum alignment deviation between leads will not to be greater than 0.2mm.
2. Maximum non-cumulative variation between tape feed holes shall not exceed 1 mm in 20 pitches.
3. Holddown tape will not exceed beyond the edge(s) of carrier tape and there shall be no exposure of adhesive.
4. There will be no more than three (3) consecutive missing components in a tape.
5. A tape trailer, having at least three feed holes are provided after the last component in a tape.
6. Splices should not interfere with the sprocket feed holes.

REMARKS

- *1 Cumulative pitch error 1.0 mm/20 pitch
 *2 To be measured at bottom of clinch
 *3 At top of body
 *4 At top of body
 *5 t1 0.3 – 0.6 mm

Disclaimer

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CDIL is a registered Trademark of
Continental Device India Limited

C-120 Naraina Industrial Area, New Delhi 110 028, India.
Telephone + 91-11-2579 6150, 5141 1112 Fax + 91-11-2579 5290, 5141 1119
email@cdil.com www.cdilsemi.com